Product data sheet

1. Product profile

1.1 General description

The BB173LX is a variable capacitance diode, fabricated in planar technology, and encapsulated in the SOD882D (DFN1006D-2) ultra small leadless SMD plastic package.

1.2 Features and benefits

- Excellent linearity
- Ultra small leadless SMD package
- $C_{d(28V)} = 2.6 \text{ pF}$; $C_{d(1V)}$ to $C_{d(28V)}$ ratio = 15
- Low series resistance

1.3 Applications

■ Voltage Controlled Oscillators (VCO)

2. Pinning information

Table 1. Pinning

Pin	Description	Simplified outline	Symbol
1	cathode	[1]	-IL
2	anode	Transparent top view	sym008

^[1] The marking bar indicates the cathode.

3. Ordering information

Table 2. Ordering information

Type number Package			
	Name	Description	Version
BB173LX	DFN1006D-2	leadless ultra small plastic package; 2 terminals; body 1 \times 0.6 \times 0.4	SOD882D



VHF variable capacitance diode

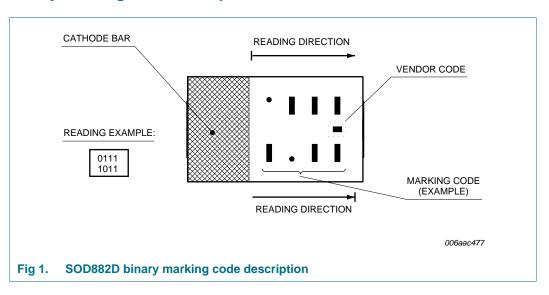
4. Marking

Table 3. Marking codes

Type number	Marking code [1]
BB173LX	1000
	1001

^[1] For SOD882D binary marking code description, see Figure 1.

4.1 Binary marking code description



5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions Min	Max	Unit
V_{R}	reverse voltage	-	32	V
I _F	forward current	-	20	mΑ
T _{stg}	storage temperature	-55	+150	°C
Tj	junction temperature	- 55	+125	°C

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6. Characteristics

 Table 5.
 Characteristics

 $T_i = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
Syllibol	Parameter	Conditions		IVIIII	Тур	IVIAX	Unit
I_R	reverse current	$V_R = 30 \text{ V}$	[1]	-	-	10	nA
		$V_R = 30 \text{ V}; T_j = 85 ^{\circ}\text{C}$	[1]	-	-	200	nΑ
r _s	diode series resistance	$f = 100 \text{ MHz}; C_d = 30 \text{ pF}$	[2]	-	0.7	-	Ω
C_d	diode capacitance	f = 1 MHz	[3]				
		V _R = 1 V		34.65	-	42.35	pF
		V _R = 28 V		2.36	2.6	2.75	pF
$C_{d(1V)}/C_{d(2V)}$	diode capacitance ratio (1 V to 2 V)	f = 1 MHz		-	1.3	-	
$C_{d(1V)}/C_{d(28V)}$	diode capacitance ratio (1 V to 28 V)	f = 1 MHz		13.5	15	-	
C _{d(25V)} /C _{d(28V)}	diode capacitance ratio (25 V to 28 V)	f = 1 MHz		-	1.08	-	

^[1] See Figure 4.

^[3] See Figure 2 and Figure 5.

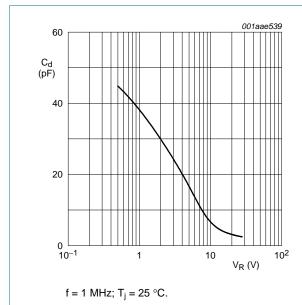


Fig 2. Diode capacitance as a function of reverse voltage; typical values

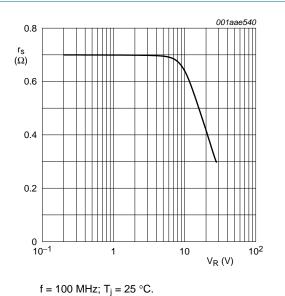


Fig 3. Diode series resistance as a function of reverse voltage; typical values

^[2] See Figure 3.

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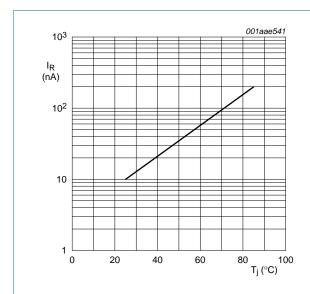


Fig 4. Reverse current as a function of junction temperature; maximum values

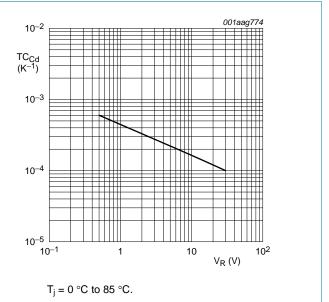


Fig 5. Diode capacitance temperature coefficient as a function of reverse voltage; typical values

7. Package outline

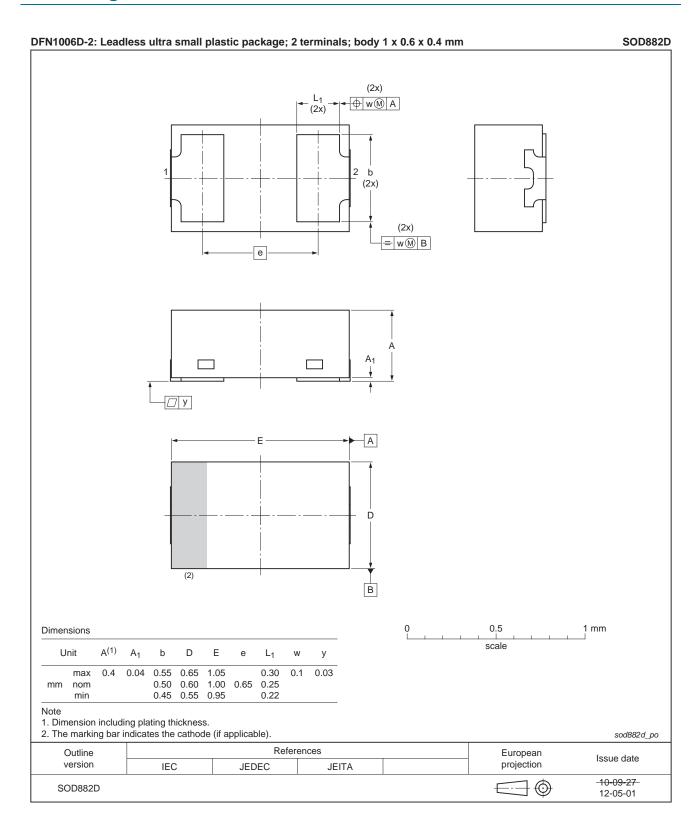


Fig 6. Package outline SOD882D (DFN1006D-2)

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8. Abbreviations

Table 6. Abbreviations

Acronym	Description
SMD	Surface Mounted Device
VHF	Very High Frequency

9. Revision history

Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BB173LX v.1	20130325	Product data sheet	-	-

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10. Legal information

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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